	Spec. No.: Date:	FRC-K-HTS-0001 /8 2017. 1. 10
Sneci	ficatio	n
Style: FRC16, 20, 32	<u></u>	
	MPLIANCE ITEM	
Product specification contain are subject to change at any If you have any questions or Agreement is necessary, ple	time without notice a Purchasing Specificatio	
	》 釜 定 電 KAMAYA E	袋妹式會社 LECTRIC CO., LTD Hokkaido Research Center Approval by: T. Sannomiya
ote: Stock conditions Temperature: +5°C ~ +35°C Relative humidity: 25% ~ 75% The period of guarantee: Within 2 year from s Solderability shall be		Drawing by: M. Shibuya

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Title: CHIP FUSIBLE RESISTORS; RECTANGULAR TYPE FRC16, 20, 32

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### 1. Scope

1.1 This specification covers the detail requirements for chip fusible resistors; rectangular type, style of FRC16, 20,32.

1.2 Applicable documents

JIS C 5201: 1994, JIS C 5202: 1990

2. Classification

Type designation shall be the following form.								
(Example)	FRC	20	С	2A	100	J	TP	
	1	2	3	4	5	6	7	
	Sty	le						
1 C	hip fusible	resistors; recta	angular	type				
2 S	ize				Style	•		
3 C	haracterist	ics symbol						
4 R	ated dissip	ation	Sym	nbol	Rated dissipa	ation		
			1,	J	0.063W			
			2	A	0.1W			
			2	В	0.125W			
5 Rated resistance $100$ E24 Series,3 digit, EX. 100>10 $\Omega$								
6 Tolerance on rated resistance								

7 Packaging form

В	Bulk (loose package)
TP	Paper taping

### 3. Rating

3.1 The ratings shall be in accordance with Table-1.

	0								
Table-1									
Otula	Rated dissipation	Temperature coefficient of	Rated resistance	Preferred number series	Tolerance on				
Style	(VV)	resistance (10 <sup>-6</sup> /°C)	range( $\Omega$ )	for resistors	rated resistance				
FRC16	0.063	± 500	3.9~51						
FRC20	0.1	± 1000	1.0~51	E24	1(,59/)				
FRC32	0.125	± 500	56~100	⊏24	J(±5%)				
FRUSZ	0.125	± 1000	1.0~51						

	Limiting	Max. overload	Fusing characteristics			Operating temperature
Style	element voltage	voltage(V)	Symbol	Fusing power	Fusing time	range(°C)
	(V)		-	(Ŵ)	(S.)	
FRC16	1.79	3.58		1.89		
FRC20	2.26	4.52	С	2.0	30 max.	-55~+125
FRC32	3.53	7.06		2.5		

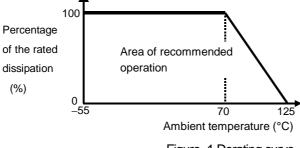
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## 3.2 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.





### 3.3 Rated voltage

Е

d.c.or a.c.r.m.s.voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

$$=$$
  $\sqrt{P \cdot R}$ 

Max. overload voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

## 4. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

Symbol	I	Packaging form		
В	Bulk (loose packa	1,000 pcs.		
TP	Paper taping 8mm width, 4mm pitches		5,000 pcs.	

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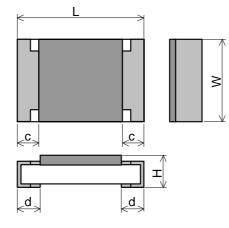
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### 5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.





	Unit: mm				
Style	L	W	Н	С	d
FRC16	1.6 ± 0.1	0.8 +0.15	$0.45 \pm 0.10$	0.3 ± 0.1	$0.3 \pm 0.1$
FRC20	2.0 ± 0.1	1.25 ± 0.10	0.6 ± 0.1	$0.4 \pm 0.2$	$0.4 \pm 0.2$
FRC32	$3.2 \pm 0.2$	1.6 ± 0.15	$0.6 \pm 0.1$	0.5 ± 0.25	$0.5 \pm 0.25$

### 5.2 Net weight (Reference)

Style	Net weight(mg)
FRC16	2.2
FRC20	6
FRC32	10

### 6. Marking

The Rated resistance shall be marked in 3 digits (E24) and marked on over coat side.

(Example) "100"  $\rightarrow$  10×10° [ $\Omega$ ]  $\rightarrow$  10 [ $\Omega$ ]

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## 7. Performance

- 7.1 The standard condition for tests shall be in accordance with Sub-clause 3, JIS C 5202: 1990.
- 7.2 The performance shall be satisfied in Table-4.

Table	-4(1)

No.	Test items	Condition of test (JIS C 5202)	Performance requirements
1	Resistance	Sub–clause 5.1 Classification of test voltage: A	Within the specified tolerance of rated resistance.
2	Temperature characteristic of resistance	Sub-clause 5.2 The resistor shall be mounted on the test substrate as shown in Figure-3-2. Test resistance shall be measured at the room temp. and temp. about 100 °C higher than the room temp	See Table–1.
3	Short time overload	Sub-clause 5.5 The resistor shall be mounted on the test substrate as shown in Figure-3-2. Test potential: 2 times rated voltage. Test period: 5 s. Test potential should not exceed limiting element voltage as shown in Table-1.	Within ± (5%+0.1Ω) No evidence of appearance damage
4	Insulation resistance	Sub-clause 5.6 The resistor shall be fixed on the test fixture as shown in Figure–5 Test potential: FRC16:100Vdc FRC20,32: 500Vdc Test period: 1 min.	1,000MΩ min.
5	Voltage proof	Sub-clause 5.7 The resistor shall be fixed on the test fixture as shown in Figure–5 Test condition: Normal pressure Test potential: FRC16: 100Vac FRC20,32: 500Vac Test period: $60^{+10}_{-0}$ s.	No flashover, fire and breakdown.
6	Fusing characteristic	Sub-clause 8.6 of EIAJ RC-2124 The resistor shall be mounted on the test substrate as shown in Figure-3-1. Fusing power; FRC16: 1.89W FRC20: 2.0W FRC32: 2.5W Test condition: No draught over the resistors. The voltage which corresponds to fusing power shall be applied until fusing. After the fusing tests, the remaining resistance shall be measured according to No.1.	Characteristics: C •Fusing time: 30 s. max. •The remaining resistance shall be exceeded more than 50 times against initial resistance. •No smoke and arc.
7	Bond strength of the face plating	Sub-clause 6.1.4(1) The resistor shall be mounted on the test substrate as shown in Figure-4. Bending value: 5 mm (Among the fulcrums: 90 mm) Duration: 10±1 s	Within ±1% No evidence of mechanical damage

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	Table-4(2)							
No.	Test items		Condition of test (JIS	C 5202)	Performance requirements			
8	Vibration	as shown Class of v 3 directio other.	se 6.3 tor shall be mounted o i in Figure–3–2. <i>ribration:</i> A ns perpendicular to the of vibration: 2h in each c	Within ±1% No evidence of mechanical damage				
9	Resistance to soldering heat	Immersio After imm		Within ±3% No evidence of appearance damage				
10	Solderability	Temp. of		The surface of terminal immersed shall be min. of 95% covered with a new coating of solder.				
11	Temperature cycling	as shown	se 7.4 tor shall be mounted o in Figure–3–2. 2: 5 cycles for duty cycle Temperature (°C) Room temp. –55±3 Room temp. 125±2	Within ±5% No evidence of appearance damage				
12	Load life in humidity	as shown Test temp 40 °C Test volta Test perio	se 7.9 tor shall be mounted o in Figure–3–2. b. & relative humidity: $\pm 2 ^{\circ}C \& 90–95 \%$ ge: Cycle of 1 h 30 min. 30 min. "OFF" at dc ra od: 1,000 $^{+48}_{0}$ h	Within ±5% No evidence of appearance damage				
13	Endurance at 70 °C	as shown Test temp Test volta	se 7.10 tor shall be mounted o in Figure–3–2. b. & relative humidity: 70 ge: Cycle of 1 h 30 min. 30 min. "OFF" at dc ra od: 1,000 <sup>+48</sup> / <sub>0</sub> h	°C±2°C "ON" and	Within ±5% No evidence of appearance damage			

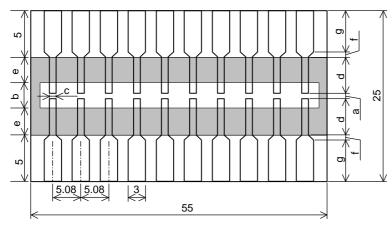
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### 8. Test substrate



:Copper clad :Solder resist

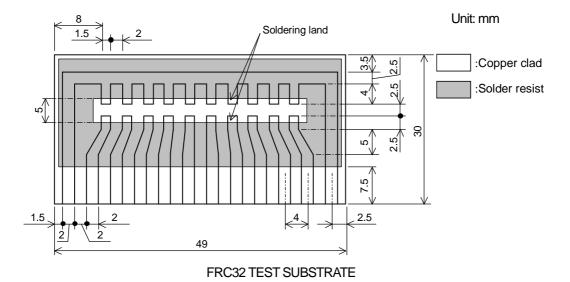
Unit:mm

Style	а	b	С	d	е	f	g	
FRC16	1.0	3.6	1.0	7.0	5.7	1.25	3.75	
FRC20	1.2	4.0	1.65	6.9	5.5	1.25	3.75	
FRC32	2.2	5.0	2.0	6.4	5.0	0.75	4.25	
FRC TEST SUBSTRATE								

Figure-3-1

Remark 1). Material: Epoxide woven glass

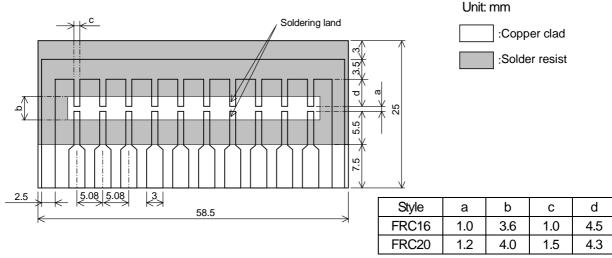
Thickness: 1.6mm Thickness of copper clad: 0.035mm



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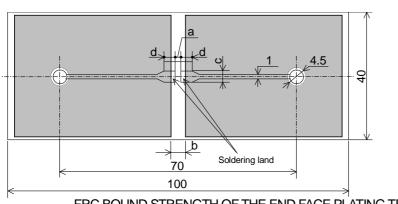
FRC16, 20 TEST SUBSTRATE

Figure-3-2

Remark 1). Material: Epoxide woven glass

Thickness: 1.6mm Thickness of copper clad: 0.035mm

2). In the case of connection by connector, the connecting terminals are gold plated. However, the plating is not necessary when the connection is made by soldering.



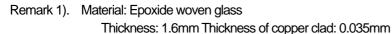
Style	а	b	С	d
FRC16	1.0	3.6	1.2	3.0
FRC20	1.2	4.0	1.65	3.0
FRC32	2.5	5.0	2.0	2.5

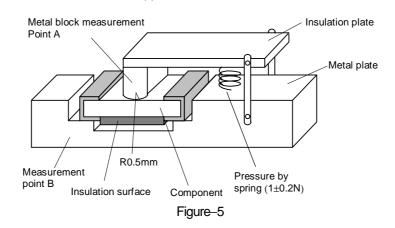
:Copper clad :Solder resist

Unit: mm

FRC BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE

Figure-4





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## 9. Taping

9.1 Applicable documents JIS C 0806–3: 2014, EIAJ ET–7200C: 2010

9 2 Taping dimensions

Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-6 and Table-5.

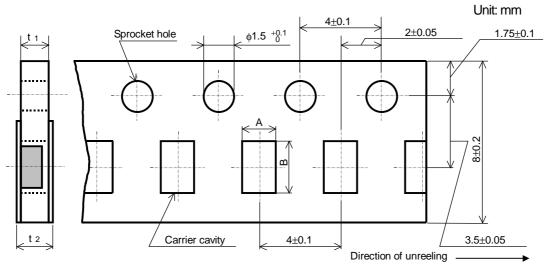
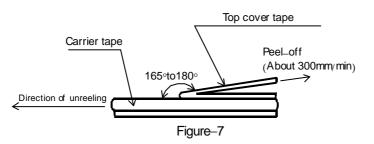


Figure-6

	Unit: mm			
Style	A	В	<b>t</b> 1	<b>t</b> 2
FRC16	1.15±0.15	1.9 <u>+</u> 0.2	0.6±0.1	0.8max.
FRC20	1.65 ± 0.15	2.5 ± 0.2	0.8±0.1	1.0max.
FRC32	2.00 ± 0.15	$3.6 \pm 0.2$		

- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following Figure-7.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.
- The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.



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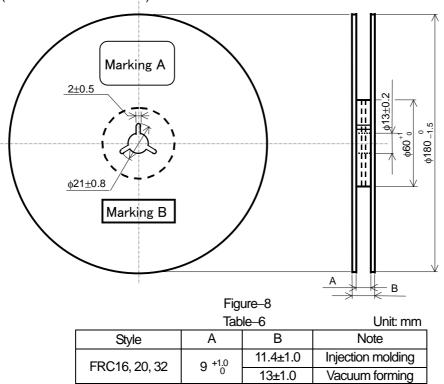
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## 9.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure–8 and Table–6. Plastic reel (Based on EIAJ ET–7200C) Unit: mm



Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

### 9.4 Leader and trailer tape.

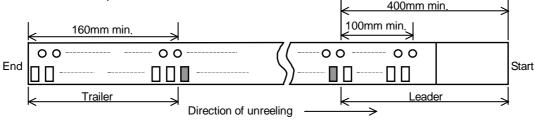


Figure-9

### 10. Marking on package

The label of a minimum package shall be legibly marked with follows.

## 10.1 Marking A

(1) Classification

(Style, Characteristics symbol, Rated dissipation Rated resistance, Tolerance on rated resistance, Packaging form) (2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others

## 10.2 Marking B(KAMAYA control label)

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